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### Understanding **Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	2880
Number of Logic Elements/Cells	-
Total RAM Bits	-
Number of I/O	111
Number of Gates	48000
Voltage - Supply	2.25V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	144-LBGA
Supplier Device Package	144-FPBGA (13x13)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microsemi/a54sx32a-ffgg144">https://www.e-xfl.com/product-detail/microsemi/a54sx32a-ffgg144</a>

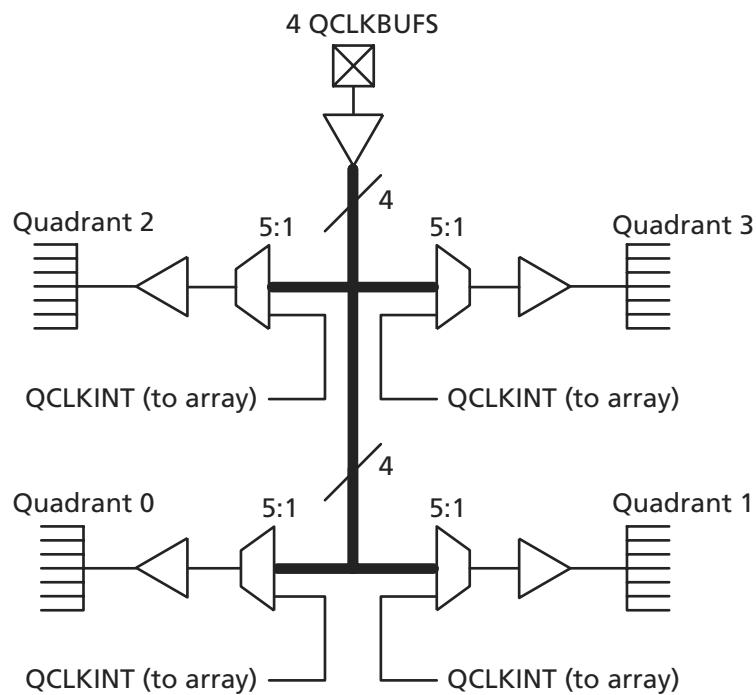


Figure 1-9 • SX-A QCLK Architecture

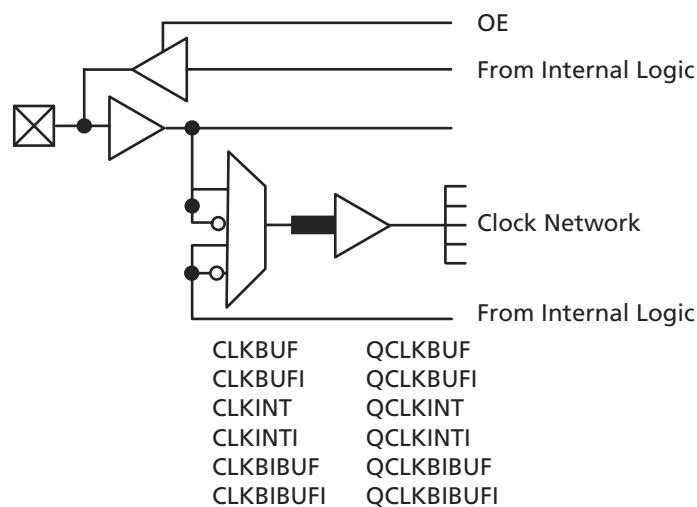


Figure 1-10 • A54SX72A Routed Clock and QCLK Buffer

## Other Architectural Features

### Technology

The Actel SX-A family is implemented on a high-voltage, twin-well CMOS process using  $0.22\text{ }\mu\text{/ }0.25\text{ }\mu$  design rules. The metal-to-metal antifuse is comprised of a combination of amorphous silicon and dielectric material with barrier metals and has a programmed ('on' state) resistance of  $25\text{ }\Omega$  with capacitance of  $1.0\text{ fF}$  for low signal impedance.

### Performance

The unique architectural features of the SX-A family enable the devices to operate with internal clock frequencies of 350 MHz, causing very fast execution of even complex logic functions. The SX-A family is an optimal platform upon which to integrate the functionality previously contained in multiple complex programmable logic devices (CPLDs). In addition, designs that previously would have required a gate array to meet performance goals can be integrated into an SX-A device with dramatic improvements in cost and time-to-market. Using timing-driven place-and-route tools, designers can achieve highly deterministic device performance.

### User Security

Reverse engineering is virtually impossible in SX-A devices because it is extremely difficult to distinguish between programmed and unprogrammed antifuses. In addition, since SX-A is a nonvolatile, single-chip solution, there is no configuration bitstream to intercept at device power-up.

The Actel FuseLock advantage ensures that unauthorized users will not be able to read back the contents of an Actel antifuse FPGA. In addition to the inherent strengths of the architecture, special security fuses that prevent internal probing and overwriting are hidden throughout the fabric of the device. They are located where they cannot be accessed or bypassed without destroying access to the rest of the device, making both invasive and more-subtle noninvasive attacks ineffective against Actel antifuse FPGAs.

Look for this symbol to ensure your valuable IP is secure (Figure 1-11).



Figure 1-11 • FuseLock

For more information, refer to Actel's *Implementation of Security in Actel Antifuse FPGAs* application note.

### I/O Modules

For a simplified I/O schematic, refer to Figure 1 in the application note, *Actel eX, SX-A, and RTSX-S I/Os*.

Each user I/O on an SX-A device can be configured as an input, an output, a tristate output, or a bidirectional pin. Mixed I/O standards can be set for individual pins, though this is only allowed with the same voltage as the input. These I/Os, combined with array registers, can achieve clock-to-output-pad timing as fast as 3.8 ns, even without the dedicated I/O registers. In most FPGAs, I/O cells that have embedded latches and flip-flops, requiring instantiation in HDL code; this is a design complication not encountered in SX-A FPGAs. Fast pin-to-pin timing ensures that the device is able to interface with any other device in the system, which in turn enables parallel design of system components and reduces overall design time. All unused I/Os are configured as tristate outputs by the Actel Designer software, for maximum flexibility when designing new boards or migrating existing designs.

SX-A I/Os should be driven by high-speed push-pull devices with a low-resistance pull-up device when being configured as tristate output buffers. If the I/O is driven by a voltage level greater than  $V_{CCA}$  and a fast push-pull device is NOT used, the high-resistance pull-up of the driver and the internal circuitry of the SX-A I/O may create a voltage divider. This voltage divider could pull the input voltage below specification for some devices connected to the driver. A logic '1' may not be correctly presented in this case. For example, if an open drain driver is used with a pull-up resistor to 5 V to provide the logic '1' input, and  $V_{CCA}$  is set to 3.3 V on the SX-A device, the input signal may be pulled down by the SX-A input.

Each I/O module has an available power-up resistor of approximately  $50\text{ k}\Omega$  that can configure the I/O in a known state during power-up. For nominal pull-up and pull-down resistor values, refer to Table 1-4 on page 1-8 of the application note *Actel eX, SX-A, and RTSX-S I/Os*. Just slightly before  $V_{CCA}$  reaches 2.5 V, the resistors are disabled, so the I/Os will be controlled by user logic. See Table 1-2 on page 1-8 and Table 1-3 on page 1-8 for more information concerning available I/O features.

## Boundary-Scan Testing (BST)

All SX-A devices are IEEE 1149.1 compliant and offer superior diagnostic and testing capabilities by providing Boundary Scan Testing (BST) and probing capabilities. The BST function is controlled through the special JTAG pins (TMS, TDI, TCK, TDO, and TRST). The functionality of the JTAG pins is defined by two available modes: Dedicated and Flexible. TMS cannot be employed as a user I/O in either mode.

### Dedicated Mode

In Dedicated mode, all JTAG pins are reserved for BST; designers cannot use them as regular I/Os. An internal pull-up resistor is automatically enabled on both TMS and TDI pins, and the TMS pin will function as defined in the IEEE 1149.1 (JTAG) specification.

To select Dedicated mode, the user must reserve the JTAG pins in Actel's Designer software. Reserve the JTAG pins by checking the **Reserve JTAG** box in the Device Selection Wizard (Figure 1-12).

The default for the software is Flexible mode; all boxes are unchecked. Table 1-5 lists the definitions of the options in the Device Selection Wizard.

### Flexible Mode

In Flexible mode, TDI, TCK, and TDO may be employed as either user I/Os or as JTAG input pins. The internal resistors on the TMS and TDI pins are not present in flexible JTAG mode.

To select the Flexible mode, uncheck the **Reserve JTAG** box in the Device Selection Wizard dialog in the Actel Designer software. In Flexible mode, TDI, TCK, and TDO pins may function as user I/Os or BST pins. The functionality is controlled by the BST Test Access Port (TAP) controller. The TAP controller receives two control inputs, TMS and TCK. Upon power-up, the TAP controller enters the Test-Logic-Reset state. In this state, TDI, TCK, and TDO function as user I/Os. The TDI, TCK, and TDO are transformed from user I/Os into BST pins when a rising edge on TCK is detected while TMS is at logic low. To return to Test-Logic Reset state, TMS must be high for at least five TCK cycles. **An external 10 k pull-up resistor to V<sub>CC</sub> should be placed on the TMS pin to pull it High by default.**

Table 1-6 describes the different configuration requirements of BST pins and their functionality in different modes.

*Table 1-6 • Boundary-Scan Pin Configurations and Functions*

Mode	Designer "Reserve JTAG" Selection	TAP Controller State
Dedicated (JTAG)	Checked	Any
Flexible (User I/O)	Unchecked	Test-Logic-Reset
Flexible (JTAG)	Unchecked	Any EXCEPT Test-Logic-Reset

*Figure 1-12 • Device Selection Wizard*

*Table 1-5 • Reserve Pin Definitions*

Pin	Function
Reserve JTAG	Keeps pins from being used and changes the behavior of JTAG pins (no pull-up on TMS)
Reserve JTAG Test Reset	Regular I/O or JTAG reset with an internal pull-up
Reserve Probe	Keeps pins from being used or regular I/O

### TRST Pin

The TRST pin functions as a dedicated Boundary-Scan Reset pin when the **Reserve JTAG Test Reset** option is selected as shown in Figure 1-12. An internal pull-up resistor is permanently enabled on the TRST pin in this mode. Actel recommends connecting this pin to ground in normal operation to keep the JTAG state controller in the Test-Logic-Reset state. When JTAG is being used, it can be left floating or can be driven high.

When the **Reserve JTAG Test Reset** option is not selected, this pin will function as a regular I/O. If unused as an I/O in the design, it will be configured as a tristated output.

Where:

$C_{EQCM}$  = Equivalent capacitance of combinatorial modules (C-cells) in pF

$C_{EQSM}$  = Equivalent capacitance of sequential modules (R-Cells) in pF

$C_{EQI}$  = Equivalent capacitance of input buffers in pF

$C_{EQO}$  = Equivalent capacitance of output buffers in pF

$C_{EQCR}$  = Equivalent capacitance of CLKA/B in pF

$C_{EQHV}$  = Variable capacitance of HCLK in pF

$C_{EQHF}$  = Fixed capacitance of HCLK in pF

$C_L$  = Output lead capacitance in pF

$f_m$  = Average logic module switching rate in MHz

$f_n$  = Average input buffer switching rate in MHz

$f_p$  = Average output buffer switching rate in MHz

$f_{q1}$  = Average CLKA rate in MHz

$f_{q2}$  = Average CLKB rate in MHz

$f_{s1}$  = Average HCLK rate in MHz

$m$  = Number of logic modules switching at  $f_m$

$n$  = Number of input buffers switching at  $f_n$

$p$  = Number of output buffers switching at  $f_p$

$q_1$  = Number of clock loads on CLKA

$q_2$  = Number of clock loads on CLKB

$r_1$  = Fixed capacitance due to CLKA

$r_2$  = Fixed capacitance due to CLKB

$s_1$  = Number of clock loads on HCLK

$x$  = Number of I/Os at logic low

$y$  = Number of I/Os at logic high

Table 2-11 • CEQ Values for SX-A Devices

	<b>A54SX08A</b>	<b>A54SX16A</b>	<b>A54SX32A</b>	<b>A54SX72A</b>
Combinatorial modules ( $C_{EQCM}$ )	1.70 pF	2.00 pF	2.00 pF	1.80 pF
Sequential modules ( $C_{EQCM}$ )	1.50 pF	1.50 pF	1.30 pF	1.50 pF
Input buffers ( $C_{EQI}$ )	1.30 pF	1.30 pF	1.30 pF	1.30 pF
Output buffers ( $C_{EQO}$ )	7.40 pF	7.40 pF	7.40 pF	7.40 pF
Routed array clocks ( $C_{EQCR}$ )	1.05 pF	1.05 pF	1.05 pF	1.05 pF
Dedicated array clocks – variable ( $C_{EQHV}$ )	0.85 pF	0.85 pF	0.85 pF	0.85 pF
Dedicated array clocks – fixed ( $C_{EQHF}$ )	30.00 pF	55.00 pF	110.00 pF	240.00 pF
Routed array clock A ( $r_1$ )	35.00 pF	50.00 pF	90.00 pF	310.00 pF

Table 2-16 • A54SX08A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>		<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>									
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)		1.3		1.5		1.7		2.6 ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)		1.1		1.3		1.5		2.2 ns
$t_{HPWH}$	Minimum Pulse Width High	1.6		1.8		2.1		2.9	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.6		1.8		2.1		2.9	ns
$t_{HCKSW}$	Maximum Skew		0.4		0.5		0.5		0.8 ns
$t_{HP}$	Minimum Period	3.2		3.6		4.2		5.8	ns
$f_{HMAX}$	Maximum Frequency		313		278		238		172 MHz
<b>Routed Array Clock Networks</b>									
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)		0.8		0.9		1.1		1.5 ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)		1.1		1.2		1.4		2 ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)		0.8		0.9		1.1		1.5 ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)		1.1		1.2		1.4		2 ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)		1.1		1.2		1.4		1.9 ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)		1.2		1.3		1.6		2.2 ns
$t_{RPWH}$	Minimum Pulse Width High	1.6		1.8		2.1		2.9	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.6		1.8		2.1		2.9	ns
$t_{RCKSW}$	Maximum Skew (Light Load)		0.7		0.8		0.9		1.3 ns
$t_{RCKSW}$	Maximum Skew (50% Load)		0.7		0.8		0.9		1.3 ns
$t_{RCKSW}$	Maximum Skew (100% Load)		0.8		0.9		1.1		1.5 ns

Table 2-17 • A54SX08A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>								
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.2		1.3		1.5		2.3 ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)		1.0		1.2		1.4 2.0 ns	
$t_{HPWH}$	Minimum Pulse Width High	1.6		1.8		2.1		2.9 ns
$t_{HPWL}$	Minimum Pulse Width Low	1.6		1.8		2.1		2.9 ns
$t_{HCKSW}$	Maximum Skew		0.4		0.4		0.5 0.8 ns	
$t_{HP}$	Minimum Period	3.2		3.6		4.2		5.8 ns
$f_{HMAX}$	Maximum Frequency		313		278		238 172 MHz	
<b>Routed Array Clock Networks</b>								
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	0.9		1.0		1.2		1.7 ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)		1.5		1.7		2.0 2.7 ns	
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	0.9		1.0		1.2		1.7 ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.5		1.7		2.0		2.7 ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	1.1		1.3		1.5		2.1 ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	1.6		1.8		2.1		2.9 ns
$t_{RPWH}$	Minimum Pulse Width High	1.6		1.8		2.1		2.9 ns
$t_{RPWL}$	Minimum Pulse Width Low	1.6		1.8		2.1		2.9 ns
$t_{RCKSW}$	Maximum Skew (Light Load)		0.8		0.9		1.1 1.5 ns	
$t_{RCKSW}$	Maximum Skew (50% Load)	0.8		1.0		1.1		1.5 ns
$t_{RCKSW}$	Maximum Skew (100% Load)	0.9		1.0		1.2		1.7 ns

Table 2-29 • A54SX32A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.25\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.7	2.0	2.2	2.6	4.0	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.7	2.0	2.2	2.6	4.0	ns
$t_{HPWH}$	Minimum Pulse Width High	1.4	1.6	1.8	2.1	2.9	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.4	1.6	1.8	2.1	2.9	ns
$t_{HCKSW}$	Maximum Skew	0.6	0.6	0.7	0.8	1.3	ns
$t_{HP}$	Minimum Period	2.8	3.2	3.6	4.2	5.8	ns
$f_{HMAX}$	Maximum Frequency	357	313	278	238	172	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	2.2	2.5	2.9	3.4	4.7	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	2.1	2.4	2.7	3.2	4.4	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	2.4	2.7	3.1	3.6	5.1	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	2.2	2.5	2.8	3.3	4.6	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	2.5	2.9	3.2	3.8	5.3	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	2.4	2.7	3.1	3.6	5.0	ns
$t_{RPWH}$	Minimum Pulse Width High	1.4	1.6	1.8	2.1	2.9	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.4	1.6	1.8	2.1	2.9	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	1.0	1.1	1.3	1.5	2.1	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	0.9	1.0	1.2	1.4	1.9	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	0.9	1.0	1.2	1.4	1.9	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-30 • A54SX32A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.7	2.0	2.2	2.6	4.0	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.7	2.0	2.2	2.6	4.0	ns
$t_{HPWH}$	Minimum Pulse Width High	1.4	1.6	1.8	2.1	2.9	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.4	1.6	1.8	2.1	2.9	ns
$t_{HCKSW}$	Maximum Skew	0.6	0.6	0.7	0.8	1.3	ns
$t_{HP}$	Minimum Period	2.8	3.2	3.6	4.2	5.8	ns
$f_{HMAX}$	Maximum Frequency	357	313	278	238	172	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	2.2	2.5	2.8	3.3	4.6	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	2.1	2.4	2.7	3.2	4.5	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	2.3	2.7	3.1	3.6	5	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	2.2	2.5	2.9	3.4	4.7	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	2.4	2.8	3.2	3.7	5.2	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	2.4	2.8	3.1	3.7	5.1	ns
$t_{RPWH}$	Minimum Pulse Width High	1.4	1.6	1.8	2.1	2.9	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.4	1.6	1.8	2.1	2.9	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	1.0	1.1	1.3	1.5	2.1	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	0.9	1.0	1.2	1.4	1.9	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	0.9	1.0	1.2	1.4	1.9	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-34 • A54SX32A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>5 V PCI Output Module Timing<sup>2</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	2.1	2.4	2.8	3.2	4.5	ns
$t_{DHL}$	Data-to-Pad High to Low	2.8	3.2	3.6	4.2	5.9	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	1.3	1.5	1.7	2.0	2.8	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	2.1	2.4	2.8	3.2	4.5	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	3.0	3.5	3.9	4.6	6.4	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.8	3.2	3.6	4.2	5.9	ns
$d_{TLH}^3$	Delta Low to High	0.016	0.016	0.02	0.022	0.032	ns/pF
$d_{THL}^3$	Delta High to Low	0.026	0.03	0.032	0.04	0.052	ns/pF
<b>5 V TTL Output Module Timing<sup>4</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	1.9	2.2	2.5	2.9	4.1	ns
$t_{DHL}$	Data-to-Pad High to Low	2.5	2.9	3.3	3.9	5.4	ns
$t_{DHLS}$	Data-to-Pad High to Low—low slew	6.6	7.6	8.6	10.1	14.2	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	2.1	2.4	2.7	3.2	4.5	ns
$t_{ENZLS}$	Enable-to-Pad, Z to L—low slew	7.4	8.4	9.5	11.0	15.4	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	1.9	2.2	2.5	2.9	4.1	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	3.6	4.2	4.7	5.6	7.8	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.5	2.9	3.3	3.9	5.4	ns
$d_{TLH}^3$	Delta Low to High	0.014	0.017	0.017	0.023	0.031	ns/pF
$d_{THL}^3$	Delta High to Low	0.023	0.029	0.031	0.037	0.051	ns/pF
$d_{THLS}^3$	Delta High to Low—low slew	0.043	0.046	0.057	0.066	0.089	ns/pF

**Notes:**

1. All -3 speed grades have been discontinued.
2. Delays based on 50 pF loading.
3. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$

where  $C_{load}$  is the load capacitance driven by the I/O in pF

$d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.
4. Delays based on 35 pF loading.

Table 2-41 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>5 V PCI Output Module Timing<sup>2</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	2.7	3.1	3.5	4.1	5.7	ns
$t_{DHL}$	Data-to-Pad High to Low	3.4	3.9	4.4	5.1	7.2	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	1.3	1.5	1.7	2.0	2.8	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	2.7	3.1	3.5	4.1	5.7	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	3.0	3.5	3.9	4.6	6.4	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	3.4	3.9	4.4	5.1	7.2	ns
$d_{TLH}^3$	Delta Low to High	0.016	0.016	0.02	0.022	0.032	ns/pF
$d_{THL}^3$	Delta High to Low	0.026	0.03	0.032	0.04	0.052	ns/pF
<b>5 V TTL Output Module Timing<sup>4</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	2.4	2.8	3.1	3.7	5.1	ns
$t_{DHL}$	Data-to-Pad High to Low	3.1	3.5	4.0	4.7	6.6	ns
$t_{DHLS}$	Data-to-Pad High to Low—low slew	7.4	8.5	9.7	11.4	15.9	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	2.1	2.4	2.7	3.2	4.5	ns
$t_{ENZLS}$	Enable-to-Pad, Z to L—low slew	7.4	8.4	9.5	11.0	15.4	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	2.4	2.8	3.1	3.7	5.1	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	3.6	4.2	4.7	5.6	7.8	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	3.1	3.5	4.0	4.7	6.6	ns
$d_{TLH}^3$	Delta Low to High	0.014	0.017	0.017	0.023	0.031	ns/pF
$d_{THL}^3$	Delta High to Low	0.023	0.029	0.031	0.037	0.051	ns/pF
$d_{THLS}^3$	Delta High to Low—low slew	0.043	0.046	0.057	0.066	0.089	ns/pF

**Notes:**

1. All -3 speed grades have been discontinued.
2. Delays based on 50 pF loading.
3. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$

where  $C_{load}$  is the load capacitance driven by the I/O in pF

$d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.
4. Delays based on 35 pF loading.

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
1	GND	GND	GND	GND
2	TDI, I/O	TDI, I/O	TDI, I/O	TDI, I/O
3	I/O	I/O	I/O	I/O
4	NC	I/O	I/O	I/O
5	I/O	I/O	I/O	I/O
6	NC	I/O	I/O	I/O
7	I/O	I/O	I/O	I/O
8	I/O	I/O	I/O	I/O
9	I/O	I/O	I/O	I/O
10	I/O	I/O	I/O	I/O
11	TMS	TMS	TMS	TMS
12	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
13	I/O	I/O	I/O	I/O
14	NC	I/O	I/O	I/O
15	I/O	I/O	I/O	I/O
16	I/O	I/O	I/O	I/O
17	NC	I/O	I/O	I/O
18	I/O	I/O	I/O	GND
19	I/O	I/O	I/O	V <sub>CCA</sub>
20	NC	I/O	I/O	I/O
21	I/O	I/O	I/O	I/O
22	I/O	I/O	I/O	I/O
23	NC	I/O	I/O	I/O
24	I/O	I/O	I/O	I/O
25	NC	NC	NC	I/O
26	GND	GND	GND	GND
27	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
28	GND	GND	GND	GND
29	I/O	I/O	I/O	I/O
30	TRST, I/O	TRST, I/O	TRST, I/O	TRST, I/O
31	NC	I/O	I/O	I/O
32	I/O	I/O	I/O	I/O
33	I/O	I/O	I/O	I/O
34	I/O	I/O	I/O	I/O
35	NC	I/O	I/O	I/O

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
36	I/O	I/O	I/O	I/O
37	I/O	I/O	I/O	I/O
38	I/O	I/O	I/O	I/O
39	NC	I/O	I/O	I/O
40	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
41	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
42	I/O	I/O	I/O	I/O
43	I/O	I/O	I/O	I/O
44	I/O	I/O	I/O	I/O
45	I/O	I/O	I/O	I/O
46	I/O	I/O	I/O	I/O
47	I/O	I/O	I/O	I/O
48	NC	I/O	I/O	I/O
49	I/O	I/O	I/O	I/O
50	NC	I/O	I/O	I/O
51	I/O	I/O	I/O	I/O
52	GND	GND	GND	GND
53	I/O	I/O	I/O	I/O
54	I/O	I/O	I/O	I/O
55	I/O	I/O	I/O	I/O
56	I/O	I/O	I/O	I/O
57	I/O	I/O	I/O	I/O
58	I/O	I/O	I/O	I/O
59	I/O	I/O	I/O	I/O
60	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
61	NC	I/O	I/O	I/O
62	I/O	I/O	I/O	I/O
63	I/O	I/O	I/O	I/O
64	NC	I/O	I/O	I/O
65	I/O	I/O	NC	I/O
66	I/O	I/O	I/O	I/O
67	NC	I/O	I/O	I/O
68	I/O	I/O	I/O	I/O
69	I/O	I/O	I/O	I/O
70	NC	I/O	I/O	I/O

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
141	NC	I/O	I/O	I/O
142	I/O	I/O	I/O	I/O
143	NC	I/O	I/O	I/O
144	I/O	I/O	I/O	I/O
145	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
146	GND	GND	GND	GND
147	I/O	I/O	I/O	I/O
148	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
149	I/O	I/O	I/O	I/O
150	I/O	I/O	I/O	I/O
151	I/O	I/O	I/O	I/O
152	I/O	I/O	I/O	I/O
153	I/O	I/O	I/O	I/O
154	I/O	I/O	I/O	I/O
155	NC	I/O	I/O	I/O
156	NC	I/O	I/O	I/O
157	GND	GND	GND	GND
158	I/O	I/O	I/O	I/O
159	I/O	I/O	I/O	I/O
160	I/O	I/O	I/O	I/O
161	I/O	I/O	I/O	I/O
162	I/O	I/O	I/O	I/O
163	I/O	I/O	I/O	I/O
164	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
165	I/O	I/O	I/O	I/O
166	I/O	I/O	I/O	I/O
167	NC	I/O	I/O	I/O
168	I/O	I/O	I/O	I/O
169	I/O	I/O	I/O	I/O
170	NC	I/O	I/O	I/O
171	I/O	I/O	I/O	I/O
172	I/O	I/O	I/O	I/O
173	NC	I/O	I/O	I/O
174	I/O	I/O	I/O	I/O
175	I/O	I/O	I/O	I/O

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
176	NC	I/O	I/O	I/O
177	I/O	I/O	I/O	I/O
178	I/O	I/O	I/O	QCLKD
179	I/O	I/O	I/O	I/O
180	CLKA	CLKA	CLKA	CLKA
181	CLKB	CLKB	CLKB	CLKB
182	NC	NC	NC	NC
183	GND	GND	GND	GND
184	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
185	GND	GND	GND	GND
186	PRA, I/O	PRA, I/O	PRA, I/O	PRA, I/O
187	I/O	I/O	I/O	V <sub>CCI</sub>
188	I/O	I/O	I/O	I/O
189	NC	I/O	I/O	I/O
190	I/O	I/O	I/O	QCLKC
191	I/O	I/O	I/O	I/O
192	NC	I/O	I/O	I/O
193	I/O	I/O	I/O	I/O
194	I/O	I/O	I/O	I/O
195	NC	I/O	I/O	I/O
196	I/O	I/O	I/O	I/O
197	I/O	I/O	I/O	I/O
198	NC	I/O	I/O	I/O
199	I/O	I/O	I/O	I/O
200	I/O	I/O	I/O	I/O
201	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
202	NC	I/O	I/O	I/O
203	NC	I/O	I/O	I/O
204	I/O	I/O	I/O	I/O
205	NC	I/O	I/O	I/O
206	I/O	I/O	I/O	I/O
207	I/O	I/O	I/O	I/O
208	TCK, I/O	TCK, I/O	TCK, I/O	TCK, I/O

100-TQFP			
Pin Number	A54SX08A Function	A54SX16A Function	A54SX32A Function
71	I/O	I/O	I/O
72	I/O	I/O	I/O
73	I/O	I/O	I/O
74	I/O	I/O	I/O
75	I/O	I/O	I/O
76	I/O	I/O	I/O
77	I/O	I/O	I/O
78	I/O	I/O	I/O
79	I/O	I/O	I/O
80	I/O	I/O	I/O
81	I/O	I/O	I/O
82	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
83	I/O	I/O	I/O
84	I/O	I/O	I/O
85	I/O	I/O	I/O
86	I/O	I/O	I/O
87	CLKA	CLKA	CLKA
88	CLKB	CLKB	CLKB
89	NC	NC	NC
90	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
91	GND	GND	GND
92	PRA, I/O	PRA, I/O	PRA, I/O
93	I/O	I/O	I/O
94	I/O	I/O	I/O
95	I/O	I/O	I/O
96	I/O	I/O	I/O
97	I/O	I/O	I/O
98	I/O	I/O	I/O
99	I/O	I/O	I/O
100	TCK, I/O	TCK, I/O	TCK, I/O

## 256-Pin FBGA

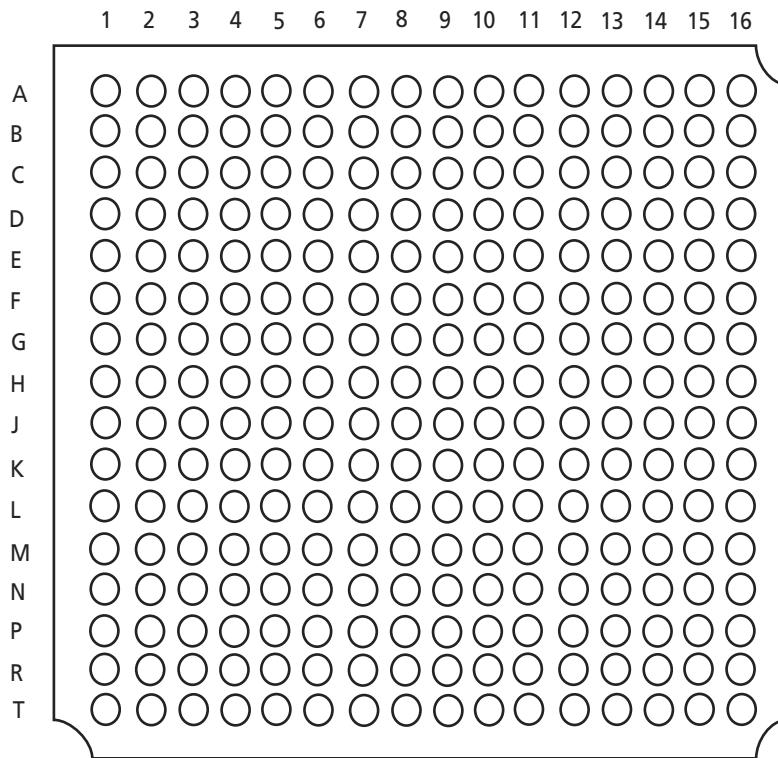


Figure 3-7 • 256-Pin FBGA (Top View)

### Note

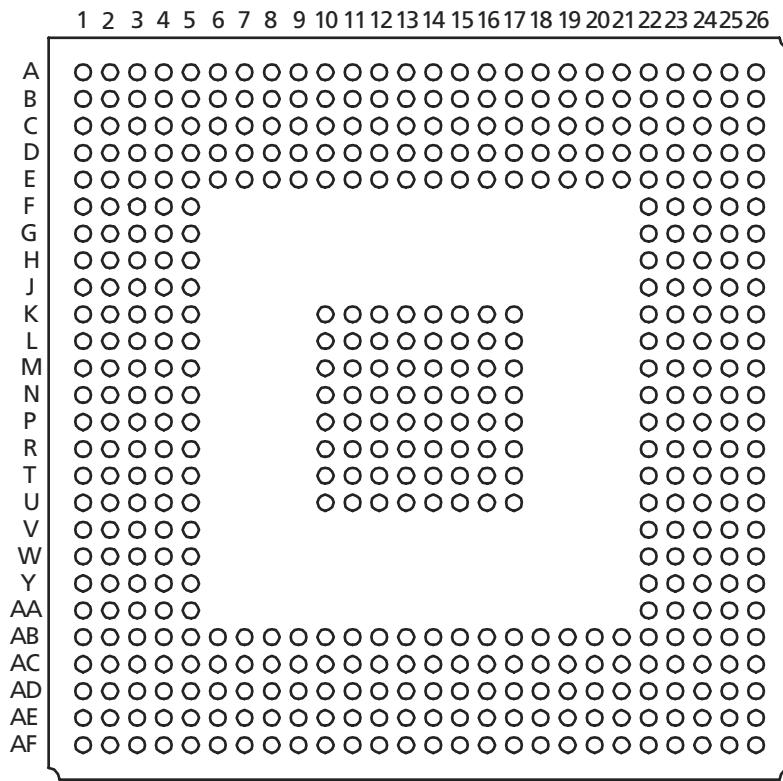
For Package Manufacturing and Environmental information, visit Resource center at  
<http://www.actel.com/products/rescenter/package/index.html>.

256-Pin FBGA			
Pin Number	A54SX16A Function	A54SX32A Function	A54SX72A Function
E11	I/O	I/O	I/O
E12	I/O	I/O	I/O
E13	NC	I/O	I/O
E14	I/O	I/O	I/O
E15	I/O	I/O	I/O
E16	I/O	I/O	I/O
F1	I/O	I/O	I/O
F2	I/O	I/O	I/O
F3	I/O	I/O	I/O
F4	TMS	TMS	TMS
F5	I/O	I/O	I/O
F6	I/O	I/O	I/O
F7	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
F8	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
F9	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
F10	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
F11	I/O	I/O	I/O
F12	VCCA	VCCA	VCCA
F13	I/O	I/O	I/O
F14	I/O	I/O	I/O
F15	I/O	I/O	I/O
F16	I/O	I/O	I/O
G1	NC	I/O	I/O
G2	I/O	I/O	I/O
G3	NC	I/O	I/O
G4	I/O	I/O	I/O
G5	I/O	I/O	I/O
G6	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
G7	GND	GND	GND
G8	GND	GND	GND
G9	GND	GND	GND
G10	GND	GND	GND
G11	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
G12	I/O	I/O	I/O
G13	GND	GND	GND
G14	NC	I/O	I/O
G15	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>

256-Pin FBGA			
Pin Number	A54SX16A Function	A54SX32A Function	A54SX72A Function
G16	I/O	I/O	I/O
H1	I/O	I/O	I/O
H2	I/O	I/O	I/O
H3	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
H4	TRST, I/O	TRST, I/O	TRST, I/O
H5	I/O	I/O	I/O
H6	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
H7	GND	GND	GND
H8	GND	GND	GND
H9	GND	GND	GND
H10	GND	GND	GND
H11	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
H12	I/O	I/O	I/O
H13	I/O	I/O	I/O
H14	I/O	I/O	I/O
H15	I/O	I/O	I/O
H16	NC	I/O	I/O
J1	NC	I/O	I/O
J2	NC	I/O	I/O
J3	NC	I/O	I/O
J4	I/O	I/O	I/O
J5	I/O	I/O	I/O
J6	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
J7	GND	GND	GND
J8	GND	GND	GND
J9	GND	GND	GND
J10	GND	GND	GND
J11	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
J12	I/O	I/O	I/O
J13	I/O	I/O	I/O
J14	I/O	I/O	I/O
J15	I/O	I/O	I/O
J16	I/O	I/O	I/O
K1	I/O	I/O	I/O
K2	I/O	I/O	I/O
K3	NC	I/O	I/O
K4	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>

256-Pin FBGA			
Pin Number	A54SX16A Function	A54SX32A Function	A54SX72A Function
P15	I/O	I/O	I/O
P16	I/O	I/O	I/O
R1	I/O	I/O	I/O
R2	GND	GND	GND
R3	I/O	I/O	I/O
R4	NC	I/O	I/O
R5	I/O	I/O	I/O
R6	I/O	I/O	I/O
R7	I/O	I/O	I/O
R8	I/O	I/O	I/O
R9	HCLK	HCLK	HCLK
R10	I/O	I/O	QCLKB
R11	I/O	I/O	I/O
R12	I/O	I/O	I/O
R13	I/O	I/O	I/O
R14	I/O	I/O	I/O
R15	GND	GND	GND
R16	GND	GND	GND
T1	GND	GND	GND
T2	I/O	I/O	I/O
T3	I/O	I/O	I/O
T4	NC	I/O	I/O
T5	I/O	I/O	I/O
T6	I/O	I/O	I/O
T7	I/O	I/O	I/O
T8	I/O	I/O	I/O
T9	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
T10	I/O	I/O	I/O
T11	I/O	I/O	I/O
T12	NC	I/O	I/O
T13	I/O	I/O	I/O
T14	I/O	I/O	I/O
T15	TDO, I/O	TDO, I/O	TDO, I/O
T16	GND	GND	GND

## **484-Pin FBGA**



**Figure 3-8 • 484-Pin FBGA (Top View)**

## Note

For Package Manufacturing and Environmental information, visit Resource center at <http://www.actel.com/products/rescenter/package/index.html>.

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
AD18	I/O	I/O
AD19	I/O	I/O
AD20	I/O	I/O
AD21	I/O	I/O
AD22	I/O	I/O
AD23	V <sub>CCI</sub>	V <sub>CCI</sub>
AD24	NC*	I/O
AD25	NC*	I/O
AD26	NC*	I/O
AE1	NC*	NC
AE2	I/O	I/O
AE3	NC*	I/O
AE4	NC*	I/O
AE5	NC*	I/O
AE6	NC*	I/O
AE7	I/O	I/O
AE8	I/O	I/O
AE9	I/O	I/O
AE10	I/O	I/O
AE11	NC*	I/O
AE12	I/O	I/O
AE13	I/O	I/O
AE14	I/O	I/O
AE15	NC*	I/O
AE16	NC*	I/O
AE17	I/O	I/O
AE18	I/O	I/O
AE19	I/O	I/O
AE20	I/O	I/O
AE21	NC*	I/O
AE22	NC*	I/O
AE23	NC*	I/O
AE24	NC*	I/O
AE25	NC*	NC
AE26	NC*	NC

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
AF1	NC*	NC
AF2	NC*	NC
AF3	NC	I/O
AF4	NC*	I/O
AF5	NC*	I/O
AF6	NC*	I/O
AF7	I/O	I/O
AF8	I/O	I/O
AF9	I/O	I/O
AF10	I/O	I/O
AF11	NC*	I/O
AF12	NC*	NC
AF13	HCLK	HCLK
AF14	I/O	QCLKB
AF15	NC*	I/O
AF16	NC*	I/O
AF17	I/O	I/O
AF18	I/O	I/O
AF19	I/O	I/O
AF20	NC*	I/O
AF21	NC*	I/O
AF22	NC*	I/O
AF23	NC*	I/O
AF24	NC*	I/O
AF25	NC*	NC
AF26	NC*	NC
B1	NC*	NC
B2	NC*	NC
B3	NC*	I/O
B4	NC*	I/O
B5	NC*	I/O
B6	I/O	I/O
B7	I/O	I/O
B8	I/O	I/O
B9	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
B10	I/O	I/O
B11	NC*	I/O
B12	NC*	I/O
B13	V <sub>CCI</sub>	V <sub>CCI</sub>
B14	CLKA	CLKA
B15	NC*	I/O
B16	NC*	I/O
B17	I/O	I/O
B18	V <sub>CCI</sub>	V <sub>CCI</sub>
B19	I/O	I/O
B20	I/O	I/O
B21	NC*	I/O
B22	NC*	I/O
B23	NC*	I/O
B24	NC*	I/O
B25	I/O	I/O
B26	NC*	NC
C1	NC*	I/O
C2	NC*	I/O
C3	NC*	I/O
C4	NC*	I/O
C5	I/O	I/O
C6	V <sub>CCI</sub>	V <sub>CCI</sub>
C7	I/O	I/O
C8	I/O	I/O
C9	V <sub>CCI</sub>	V <sub>CCI</sub>
C10	I/O	I/O
C11	I/O	I/O
C12	I/O	I/O
C13	PRA, I/O	PRA, I/O
C14	I/O	I/O
C15	I/O	QCLKD
C16	I/O	I/O
C17	I/O	I/O
C18	I/O	I/O

**Note:** \*These pins must be left floating on the A54SX32A device.

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
K10	GND	GND
K11	GND	GND
K12	GND	GND
K13	GND	GND
K14	GND	GND
K15	GND	GND
K16	GND	GND
K17	GND	GND
K22	I/O	I/O
K23	I/O	I/O
K24	NC*	NC
K25	NC*	I/O
K26	NC*	I/O
L1	NC*	I/O
L2	NC*	I/O
L3	I/O	I/O
L4	I/O	I/O
L5	I/O	I/O
L10	GND	GND
L11	GND	GND
L12	GND	GND
L13	GND	GND
L14	GND	GND
L15	GND	GND
L16	GND	GND
L17	GND	GND
L22	I/O	I/O
L23	I/O	I/O
L24	I/O	I/O
L25	I/O	I/O
L26	I/O	I/O
M1	NC*	NC
M2	I/O	I/O
M3	I/O	I/O
M4	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
M5	I/O	I/O
M10	GND	GND
M11	GND	GND
M12	GND	GND
M13	GND	GND
M14	GND	GND
M15	GND	GND
M16	GND	GND
M17	GND	GND
M22	I/O	I/O
M23	I/O	I/O
M24	I/O	I/O
M25	NC*	I/O
M26	NC*	I/O
N1	I/O	I/O
N2	V <sub>CCI</sub>	V <sub>CCI</sub>
N3	I/O	I/O
N4	I/O	I/O
N5	I/O	I/O
N10	GND	GND
N11	GND	GND
N12	GND	GND
N13	GND	GND
N14	GND	GND
N15	GND	GND
N16	GND	GND
N17	GND	GND
N22	V <sub>CCA</sub>	V <sub>CCA</sub>
N23	I/O	I/O
N24	I/O	I/O
N25	I/O	I/O
N26	NC*	NC
P1	NC*	I/O
P2	NC*	I/O
P3	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
P4	I/O	I/O
P5	V <sub>CCA</sub>	V <sub>CCA</sub>
P10	GND	GND
P11	GND	GND
P12	GND	GND
P13	GND	GND
P14	GND	GND
P15	GND	GND
P16	GND	GND
P17	GND	GND
P22	I/O	I/O
P23	I/O	I/O
P24	V <sub>CCI</sub>	V <sub>CCI</sub>
P25	I/O	I/O
P26	I/O	I/O
R1	NC*	I/O
R2	NC*	I/O
R3	I/O	I/O
R4	I/O	I/O
R5	TRST, I/O	TRST, I/O
R10	GND	GND
R11	GND	GND
R12	GND	GND
R13	GND	GND
R14	GND	GND
R15	GND	GND
R16	GND	GND
R17	GND	GND
R22	I/O	I/O
R23	I/O	I/O
R24	I/O	I/O
R25	NC*	I/O
R26	NC*	I/O
T1	NC*	I/O
T2	NC*	I/O

**Note:** \*These pins must be left floating on the A54SX32A device.

## Datasheet Categories

In order to provide the latest information to designers, some datasheets are published before data has been fully characterized. Datasheets are designated as "Product Brief," "Advanced," "Production," and "Datasheet Supplement." The definitions of these categories are as follows:

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The product brief is a summarized version of a datasheet (advanced or production) containing general product information. This brief gives an overview of specific device and family information.

### Advanced

This datasheet version contains initial estimated information based on simulation, other products, devices, or speed grades. This information can be used as estimates, but not for production.

### Unmarked (production)

This datasheet version contains information that is considered to be final.

### Datasheet Supplement

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